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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/646,444	08/21/2003	Yun-Hyeok Im	9898-320	9520
7590 03/26/2004  MARGER JOHNSON & McCOLLOM, P.C. 1030 S.W. Morrison Street Portland, OR 97205			EXAMINER	
			GREENE, PERSHELLE L	
			ART UNIT	PAPER NUMBER
			2826	
			DATE MAILED: 03/26/2004	

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)				
	10/646,444	IM ET AL.				
Office Action Summary	Examiner	Art Unit				
	Pershelle Greene	2826				
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the	correspondence address				
A SHORTENED STATUTORY PERIOD FOR REPL' THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period v - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be tile within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	mely filed ys will be considered timely. In the mailing date of this communication. ED (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on 21 A						
· <u> </u>	7					
Since this application is in condition for allowance except for formal matters, prosecution as to the ments is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
closed in accordance with the practice under E	x parte Quayle, 1935 C.D. 11, 4	53 O.G. 213.				
Disposition of Claims						
4) ☐ Claim(s) 1-4 is/are pending in the application. 4a) Of the above claim(s) is/are withdray  5) ☐ Claim(s) is/are allowed.  6) ☐ Claim(s) 1-4 is/are rejected.  7) ☐ Claim(s) is/are objected to.  8) ☐ Claim(s) are subject to restriction and/o						
Application Papers						
9) The specification is objected to by the Examine	r					
·	epted or b) objected to by the					
Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct						
11) The oath or declaration is objected to by the Ex						
,						
Priority under 35 U.S.C. § 119						
<ul> <li>12) ☐ Acknowledgment is made of a claim for foreign</li> <li>a) ☒ All b) ☐ Some * c) ☐ None of:</li> <li>1. ☐ Certified copies of the priority documents</li> <li>2. ☒ Certified copies of the priority documents</li> <li>3. ☐ Copies of the certified copies of the priority application from the International Bureau</li> </ul>	s have been received. s have been received in Applicat rity documents have been receiv	ion No. <u>10/271094</u> .				
* See the attached detailed Office action for a list		ed.				
Attachment(s)						
1) X Notice of References Cited (PTO-892)	4) Interview Summary					
<ul> <li>2) Notice of Draftsperson's Patent Drawing Review (PTO-948)</li> <li>3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)</li> <li>Paper No(s)/Mail Date <u>8/21/03</u>.</li> </ul>	Paper No(s)/Mail D  5) Notice of Informal I  6) Other:	late Patent Application (PTO-152)				

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Art Unit: 2826

Serial Number: 10/271094 Attorney's Docket #: 9898-253

Filing Date: 8/21/03

Applicant: Im et al.

Examiner: Pershelle Greene

## **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-4 are being rejected under 35 U.S.C. 103(a) as being unpatentable over Mertol (U.S. Patent # 5,909,056), in view of Hirai (U.S. Patent # 6,369,380).

As to claim 1, Mertol discloses a high performance heat spreader for flip chip packages having all of the claimed subject matter:

- A. "a package substrate is met by the substrate 306. Refer to figure 3;
- B. "a semiconductor chip attached to the substrate" is met by the chip 311;
- C. "a TIM formed on the semiconductor chip" is met by the TIM 302;
- D. "a dam that substantially surrounds the TIM" is met by the dam 310 surrounding the TIM 302; and
- E. "a lid placed over the TIM to contact a surface thereof" is met by the lid 301.

F. "wherein the dam is formed ... and TIM are injected" is met by the dam 310 formed on the substrate 306 and in contact with the sides of the TIM 302 and the semiconductor chip 311, wherein the lid 301 further comprises a supporter 303 for supporting the dam.

Mertol fails to explicitly show the lid comprising injection holes through which materials are required to form the dam and TIM are injected.

Hirai is cited for showing a light receiver unit having a light receiving element and a packaging cover. Specifically, Hirai shows injection holes 18 through which materials required to form the dam and TIM are injected. It would have been obvious to one of ordinary skill in the art to use the injection holes of Hirai for the purpose of injecting a material into the package.

As to claim 2, Mertol shows the lid 301 being attached to the substrate 306 via a sealant 305 and the lid covers the semiconductor chip and the dam.

As to claims 3 and 4, Hirai discloses a dam 19 being formed of a thermosetting epoxy that is not liquefied below about 125°C.

## Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Pershelle Greene whose telephone number is 571-272-1917. The examiner can normally be reached on M-F 8:30am - 5:00pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nathan Flynn can be reached on 571-272-1915. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

NATHAN J. FLYNN SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2800

PLG March 18, 2004